

Description

The SI7336ADP-T1-E3 uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

V_{DS} = 30V I_D =150A

 $R_{DS(ON)} < 2.4 \text{m}\Omega \text{ V}_{GS} = 10 \text{V}$

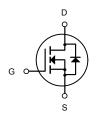
Application

Battery protection

Load switch

Uninterruptible power supply

DFN5X6-8L (PowerPAK-SO-8)



N-Channel MOSFET

Package Marking and Ordering Information

| Product ID | Pack | Brand | Qty(PCS) |
|-----------------|------------------------------|------------|----------|
| SI7336ADP-T1-E3 | DFN5X6-8L (PowerPAK-SO-8) | HXY MOSFET | 5000 |

Absolute Maximum Ratings (Tc=25 ℃ unless otherwise noted)

| Symbol | Parameter | Rating | Units | | |
|---------------------------------------|--|------------|-------|--|--|
| Vos | Drain-Source Voltage | 30 | | | |
| Vgs | Gate-Source Voltage | V | | | |
| I _D @T _C =25°C | Continuous Drain Current, V _{GS} @ 10V ¹ | 150 | А | | |
| I _D @T _C =100°C | Continuous Drain Current, V _{GS} @ 10V ¹ | 80 | Α | | |
| Іом | Pulsed Drain Current ² | 160 | А | | |
| EAS | Single Pulse Avalanche Energy ³ | 180 | mJ | | |
| las | Avalanche Current | 60 | Α | | |
| P _D @T _C =25°C | Total Power Dissipation ⁴ | 187 | W | | |
| Тѕтс | Storage Temperature Range | -55 to 150 | °C | | |
| TJ | Operating Junction Temperature Range | -55 to 150 | °C | | |
| Reja | Thermal Resistance Junction-Ambient ¹ | 62 | °C/W | | |
| Rejc | Reuc Thermal Resistance Junction-Case ¹ | | °C/W | | |

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

| Symbol | Parameter Conditions | | Min. | Тур. | Max. | Unit | |
|----------------------------------|--|---|------|-------|------|-------|--|
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V , I _D =250uA | 30 | | | V | |
| $\triangle BV_{DSS}/\triangle T$ | BV _{DSS} Temperature Coefficient | Reference to 25°C , I _D =1mA | | 0.014 | | V/°C | |
| R _{DS(ON)} | Static Drain-Source On-Resistance ² | V _{GS} =10V , I _D =30A | | 2 | 2.4 | mΩ | |
| | Static Drain-Source On-Resistance | V _{GS} =4.5V , I _D =15A | | 2.5 | 3.2 | | |
| V _{GS(th)} | Gate Threshold Voltage | V -V 1 -250A | 1.2 | | 2.5 | V | |
| $\triangle V_{GS(th)}$ | V _{GS(th)} Temperature Coefficient | V _{GS} =V _{DS} , I _D =250uA | | -4 | | mV/°C | |
| | Drain Course Lookens Current | V _{DS} =24V , V _{GS} =0V , T _J =25°C | | | 1 | | |
| I _{DSS} | Drain-Source Leakage Current | V _{DS} =24V , V _{GS} =0V , T _J =55°C | | | 5 | uA | |
| Igss | Gate-Source Leakage Current | V _{GS} =±20V , V _{DS} =0V | | | ±100 | nA | |
| gfs | Forward Transconductance | V _{DS} =5V , I _D =30A | | 50 | | S | |
| Rg | Gate Resistance | V _{DS} =0V , V _{GS} =0V , f=1MHz | | 1.7 | | Ω | |
| Qg | Total Gate Charge (4.5V) | | | 56.9 | | | |
| Qgs | Gate-Source Charge | V _{DS} =15V , V _{GS} =10V , I _D =15A | | 13.8 | | nC | |
| Q _{gd} | Gate-Drain Charge | | | 23.5 | | 1 | |
| T _{d(on)} | Turn-On Delay Time | | | 20.1 | | | |
| Tr | Rise Time | V_{DD} =15V , V_{GS} =10V , R_{G} =3.3 Ω , | | 6.3 | | | |
| T _{d(off)} | Turn-Off Delay Time | I _D =1A | | 124.6 | | ns | |
| T _f | Fall Time | | | 15.8 | | | |
| Ciss | Input Capacitance | | | 4345 | | | |
| Coss | Output Capacitance | V _{DS} =15V , V _{GS} =0V , f=1MHz | | 340 | | pF | |
| Crss | Reverse Transfer Capacitance | | | 225 | | | |

Diode Characteristics

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|----------|--|---|------|------|------|------|
| Is | Continuous Source Current ^{1,6} | V _G =V _D =0V , Force Current | | | 150 | Α |
| V_{SD} | Diode Forward Voltage ² | V _{GS} =0V , I _S =1A , T _J =25°C | | | 1.2 | V |

Note

- 1. The data tested by surface mounted on a 1 inch FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V,L=0.1mH, I_{AS} =60A
- 4.The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as I_{D} and I_{DM} , in real applications , should be limited by total power dissipation.
- 6. Package limitation current is 85A.



Typical Characteristics

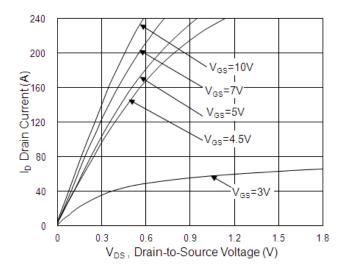


Fig.1 Typical Output Characteristics

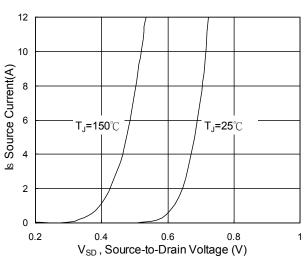


Fig.3 Forward Characteristics of Reverse

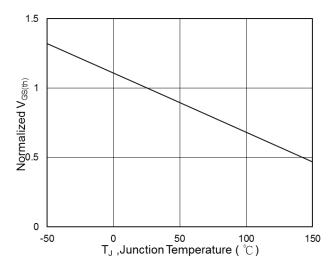


Fig.5 Normalized $V_{GS(th)}$ v.s T_J

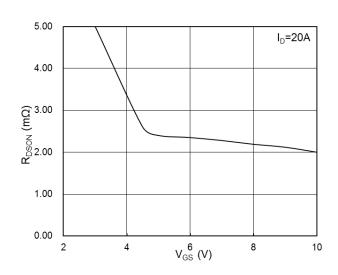


Fig.2 On-Resistance v.s Gate-Source

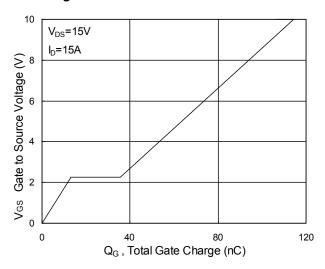


Fig.4 Gate-Charge Characteristics

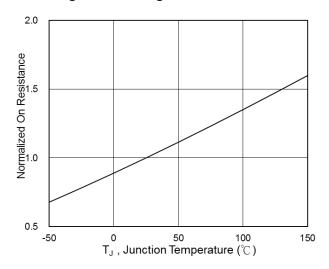
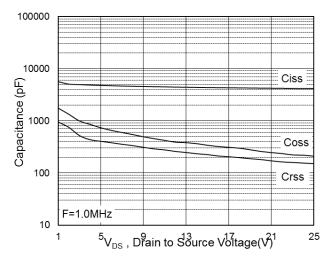


Fig.6 Normalized R_{DSON} v.s T_J



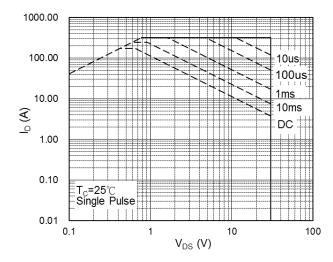


Fig.7 Capacitance

Fig.8 Safe Operating Area

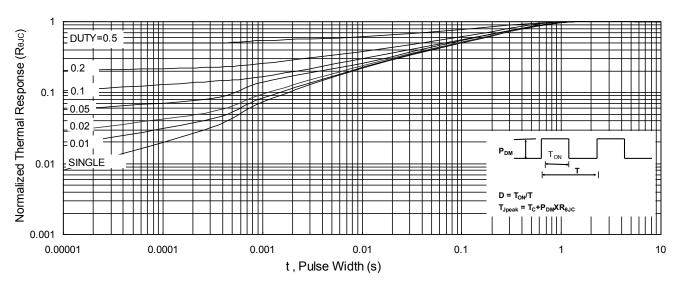
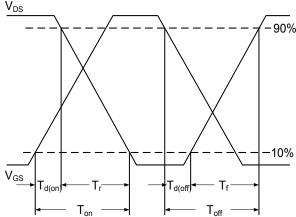


Fig.9 Normalized Maximum Transient Thermal Impedance





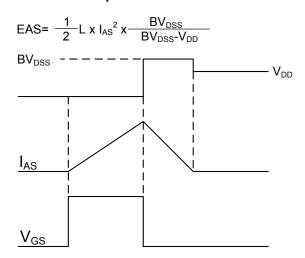
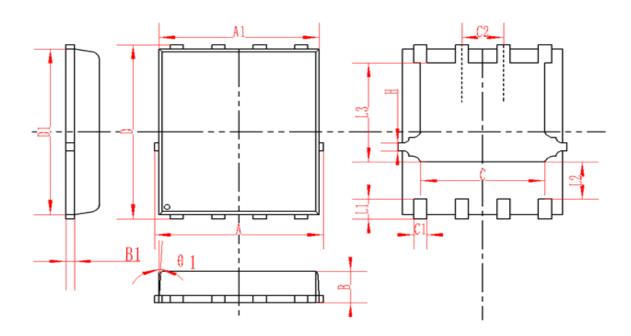


Fig.10 Switching Time Waveform Fig.11 Unclamped Inductive Switching Waveform



DFN3X3-8L(PowerPAK-SO-8) Package Information



| SYMBOL | | MM | | | INCH | | |
|----------|----------|------|-------|----------|-------|-------|--|
| STIVIDOL | MIN | NOM | MAX | MIN | NOM | MAX | |
| А | 4.95 | 5 | 5.05 | 0.195 | 0.197 | 0.199 | |
| A1 | 4.82 | 4.9 | 4.98 | 0.190 | 0.193 | 0.196 | |
| D | 5.98 | 6 | 6.02 | 0.235 | 0.236 | 0.237 | |
| D1 | 5.67 | 5.75 | 5.83 | 0.223 | 0.226 | 0.230 | |
| В | 0.9 | 0.95 | 1 | 0.035 | 0.037 | 0.039 | |
| B1 | 0.254REF | | | 0.010REF | | | |
| С | 3.95 | 4 | 4.05 | 0.156 | 0.157 | 0.159 | |
| C1 | 0.35 | 0.4 | 0.45 | 0.014 | 0.016 | 0.018 | |
| C2 | 1.27TYP | | | 0.5TYP | | | |
| θ1 | 8° | 10° | 12° | 8° | 10° | 12° | |
| L1 | 0.63 | 0.64 | 0.65 | 0.025 | 0.025 | 0.026 | |
| L2 | 1.2 | 1.3 | 1.4 | 0.047 | 0.051 | 0.055 | |
| L3 | 3.415 | 3.42 | 3.425 | 0.134 | 0.135 | 0.135 | |
| Н | 0.24 | 0.25 | 0.26 | 0.009 | 0.010 | 0.010 | |



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